P-Channel 12 V (D-S) MOSFET

PRODUCT SUMMARY			
V_{DS} (V)	$R_{DS(on)}$ (Ω) (MAX.)	I_D (A) [e]	Q_g (TYP.)
-12	0.026 at V_{GS} = -4.5 V	-16	21 nC
	0.035 at V_{GS} = -2.5 V	-16	
	0.055 at V_{GS} = -1.8 V	-13	
	0.092 at V_{GS} = -1.5 V	-2.5	

FEATURES

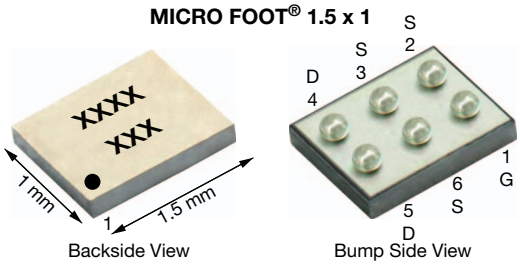
- TrenchFET® power MOSFET
- Ultra-small 1.5 mm x 1 mm maximum outline
- Ultra-thin 0.59 mm maximum height
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Pb-free

RoHS COMPLIANT

HALOGEN FREE

MICRO FOOT® 1.5 x 1



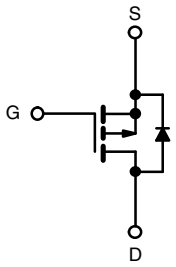
Backside View | Bump Side View

Marking Code: xxxx = 8483
xxx = Date / lot traceability code

Ordering Information:
Si8483DB-T2-E1 (Lead (Pb)-free and halogen-free)

APPLICATIONS

- Load switch for smart phones, tablet PCs, and mobile computing
  - Low voltage drop
  - Low power consumption
  - Increased battery life



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V_{DS}	-12	V
Gate-Source Voltage		V_{GS}	± 10	
Continuous Drain Current (T_J = 150 °C)	T_C = 25 °C	I_D	-16	A
	T_C = 70 °C		-15	
	T_A = 25 °C		-8.7 [a, b]	
	T_A = 70 °C		-7 [a, b]	
Pulsed Drain Current		I_{DM}	-25	
Continuous Source-Drain Diode Current	T_C = 25 °C	I_S	-10.8	
	T_A = 25 °C		-2.3 [a, b]	
Maximum Power Dissipation	T_C = 25 °C	P_D	13	W
	T_C = 70 °C		8.4	
	T_A = 25 °C		2.77 [a, b]	
	T_A = 70 °C		1.77 [a, b]	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55 to +150	°C
Package Reflow Conditions [c]	IR/Convection		260	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum Junction-to-Ambient [a, f]		R_{thJA}	37	45	°C/W
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	7	9.5	

Notes

a. Surface mounted on 1" x 1" FR4 board.
b. t = 10 s.
c. Refer to IPC/JEDEC® (J-STD-020), no manual or hand soldering.
d. Case is defined as the top surface of the package.
e. Based on T_C = 25 °C.
f. Maximum under steady state conditions is 85 °C/W.

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SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)						
PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Static						
Drain-Source Breakdown Voltage	V_{DS}	V_{GS} = 0, I_D = -250 µA	-12	-	-	V
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	I_D = -250 µA	-	-7	-	mV/°C
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$		-	2.8	-	
Gate-Source Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = -250 µA	-0.4	-	-0.8	V
Gate-Source Leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 10 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = -12 V, V_{GS} = 0 V	-	-	-1	µA
		V_{DS} = -12 V, V_{GS} = 0 V, T_J = 70 °C	-	-	-10	
On-State Drain Current [a]	$I_{D(on)}$	$V_{DS} \leq$ -5 V, V_{GS} = -4.5 V	-5	-	-	A
Drain-Source On-State Resistance [a]	$R_{DS(on)}$	V_{GS} = -4.5 V, I_D = -1.5 A	-	0.022	0.026	Ω
		V_{GS} = -2.5 V, I_D = -1.5 A	-	0.028	0.035	
		V_{GS} = -1.8 V, I_D = -1 A	-	0.040	0.055	
		V_{GS} = -1.5 V, I_D = -0.5 A	-	0.056	0.092	
Forward Transconductance [a]	g_{fs}	V_{DS} = -6 V, I_D = -1.5 A	-	10	-	S
Dynamic [b]						
Input Capacitance	C_{iss}	V_{DS} = -6 V, V_{GS} = 0 V, f = 1 MHz	-	1840	-	pF
Output Capacitance	C_{oss}		-	410	-	
Reverse Transfer Capacitance	C_{rss}		-	380	-	
Total Gate Charge	Q_g	V_{DS} = -6 V, V_{GS} = -10 V, I_D = -1.5 A	-	43	65	nC
		V_{DS} = -6 V, V_{GS} = -4.5 V, I_D = -1.5 A	-	21	32	
Gate-Source Charge	Q_{gs}		-	2.1	-	
Gate-Drain Charge	Q_{gd}		-	4.8	-	
Gate Resistance	R_g	V_{GS} = -0.1 V, f = 1 MHz	-	2.2	-	Ω
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = -6 V, R_L = 4 Ω $I_D \cong$ -1.5 A, V_{GEN} = -4.5 V, R_g = 1 Ω	-	20	40	ns
Rise Time	t_r		-	25	50	
Turn-Off Delay Time	$t_{d(off)}$		-	40	80	
Fall Time	t_f		-	10	20	
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = -6 V, R_L = 4 Ω $I_D \cong$ -1.5 A, V_{GEN} = -10V, R_g = 1 Ω	-	10	20	
Rise Time	t_r		-	10	20	
Turn-Off Delay Time	$t_{d(off)}$		-	40	80	
Fall Time	t_f		-	10	20	
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I_S	T_C = 25 °C	-	-	-10.8	A
Pulse Diode Forward Current	I_{SM}		-	-	-25	
Body Diode Voltage	V_{SD}	I_S = -1.5 A, V_{GS} = 0	-	-0.8	-1.2	V
Body Diode Reverse Recovery Time	t_{rr}	I_F = -1.5 A, dI/dt = 100 A/µs, T_J = 25 °C	-	30	60	ns
Body Diode Reverse Recovery Charge	Q_{rr}		-	12	25	nC
Reverse Recovery Fall Time	t_a		-	11.5	-	ns
Reverse Recovery Rise Time	t_b		-	18.5	-	

Notes

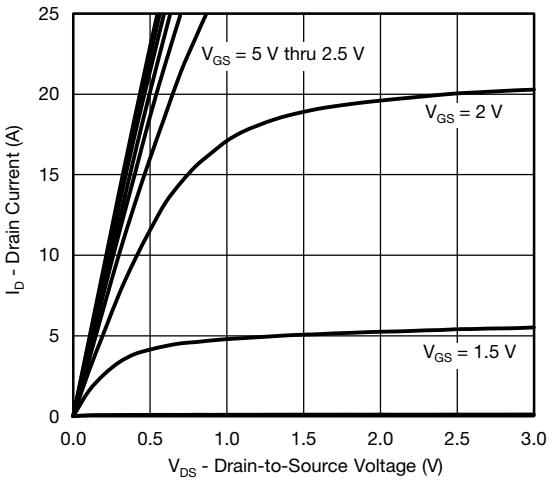
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.

b. Guaranteed by design, not subject to production testing.

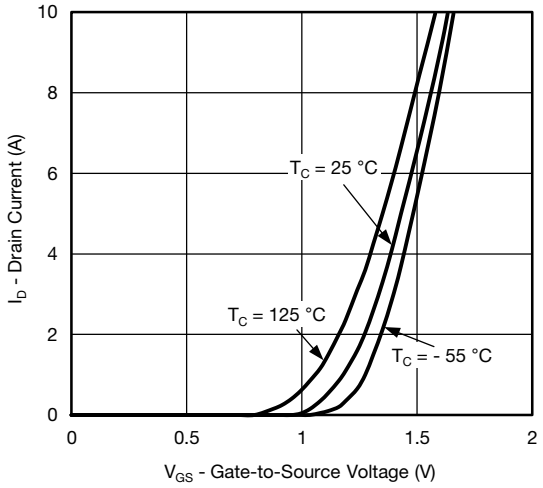
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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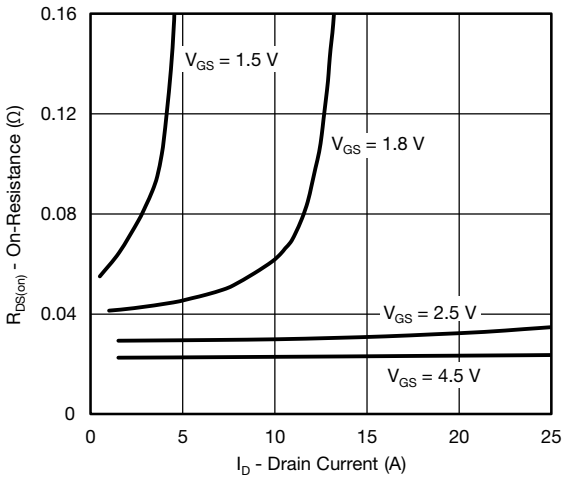
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



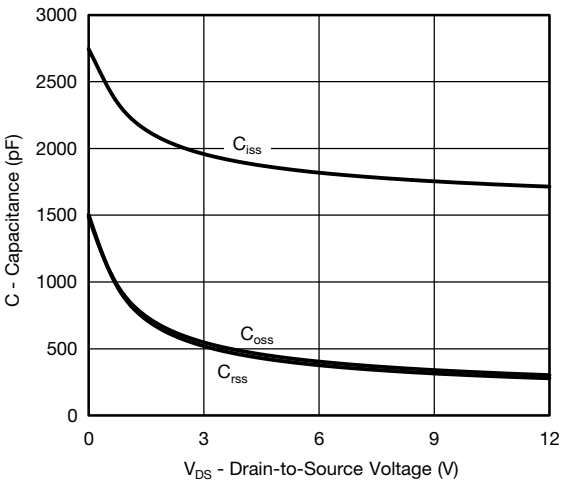
Output Characteristics



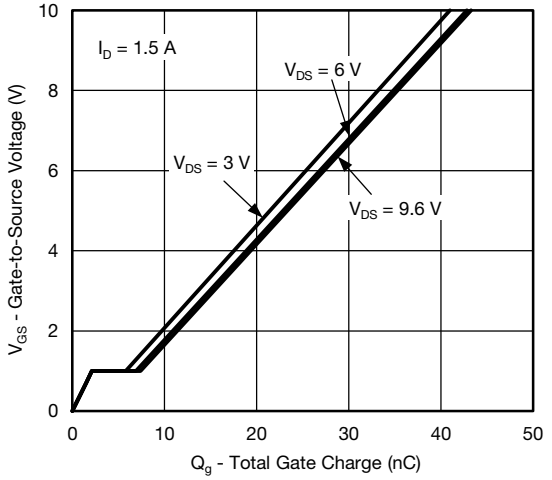
Transfer Characteristics



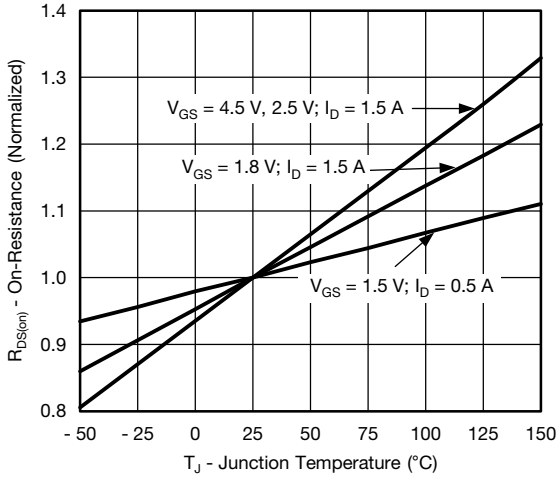
On-Resistance vs. Drain Current and Gate Voltage



Capacitance



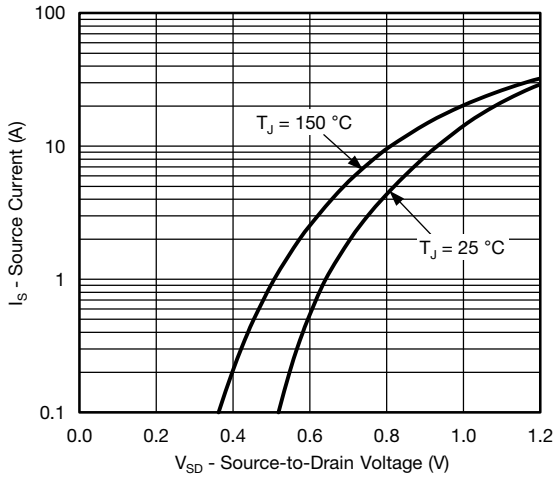
Gate Charge



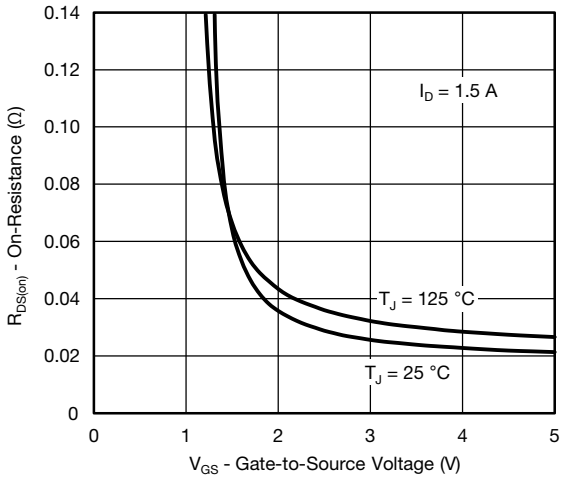
On-Resistance vs. Junction Temperature

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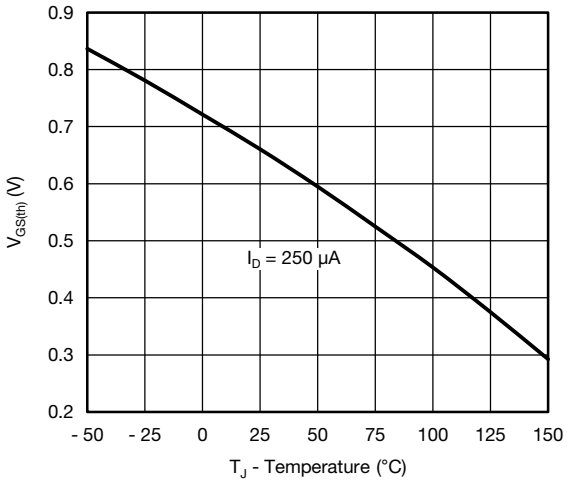
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



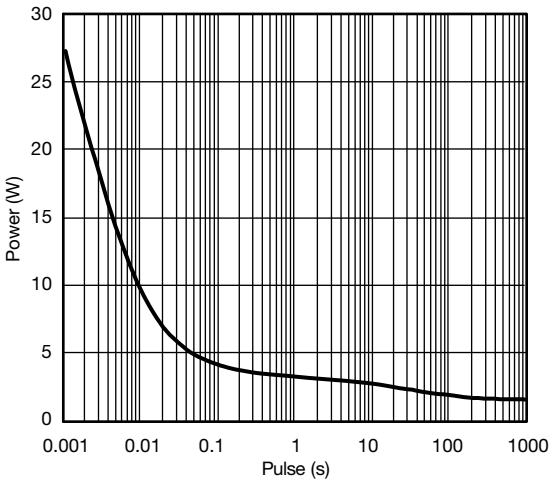
Source-Drain Diode Forward Voltage



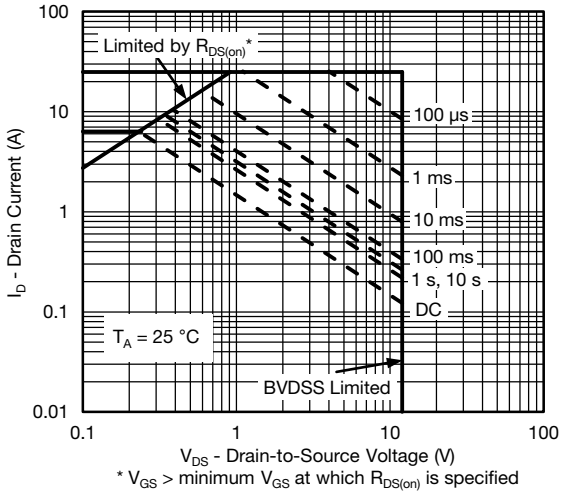
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



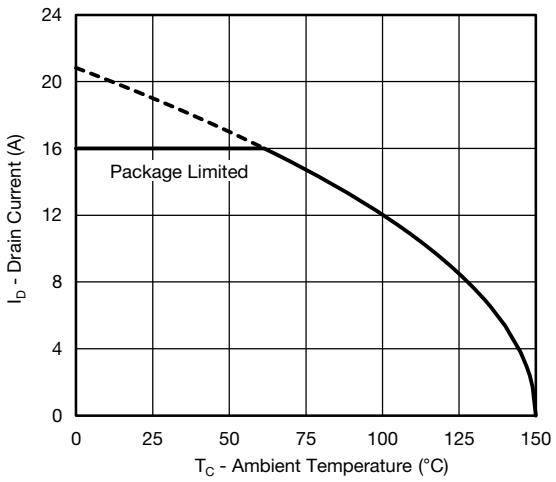
Single Pulse Power, Junction-to-Ambient



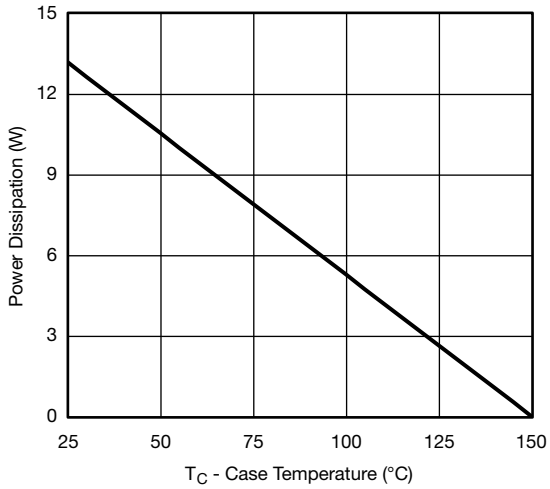
Safe Operating Area, Junction-to-Ambient

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating*

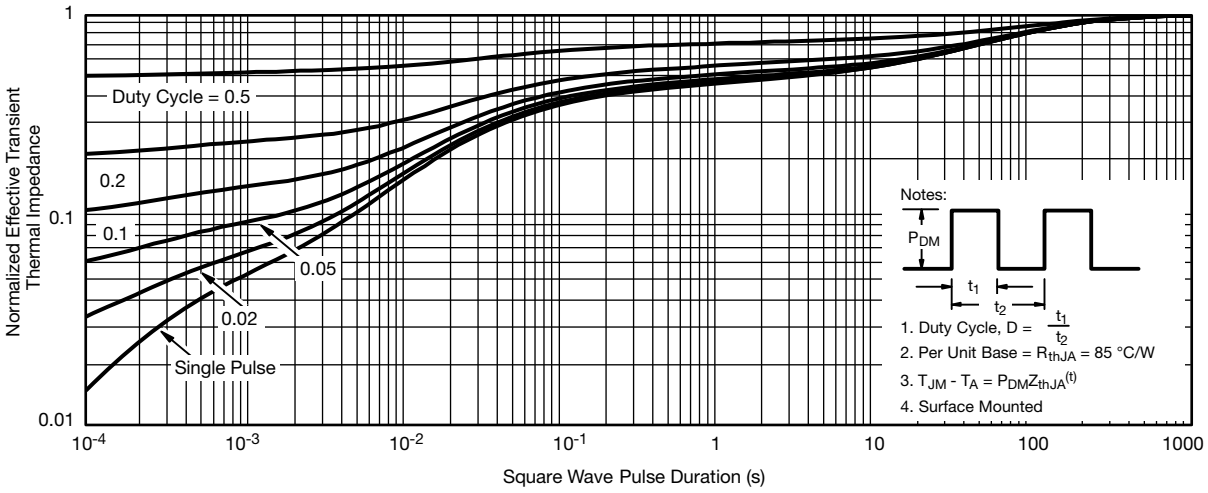


Power Derating

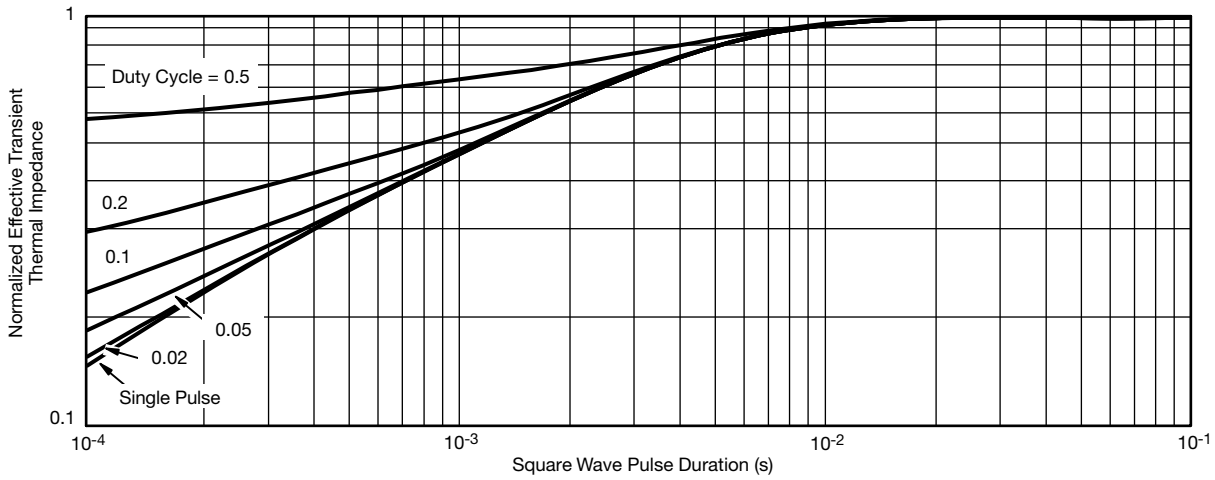
* The power dissipation P_D is based on T_J (max.) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

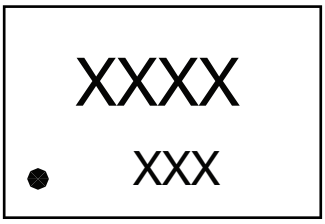


Normalized Thermal Transient Impedance, Junction-to-Case

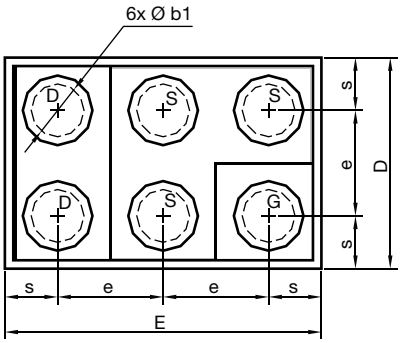
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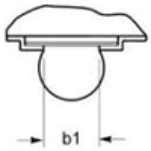
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MICRO FOOT®: 6-Bump
(1.5 mm x 1 mm, 0.5 mm Pitch, 0.250 mm Bump Height)

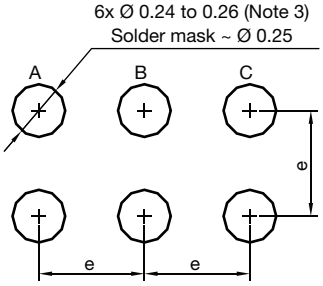


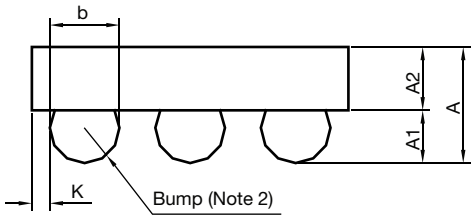
Mark on Backside of Die





NOTE 5





Recommended Land Pattern

Notes

(unless otherwise specified)

1. Six (6) solder bumps are 95.5/3.8/0.7 Sn/Ag/Cu.
2. Backside surface is coated with a Ti/Ni/Ag layer.
3. Non-solder mask defined copper landing pad.
4. Laser marks on the silicon die back.
5. “b1” is the diameter of the solderable substrate surface, defined by an opening in the solder resist layer solder mask defined.
6. • is the location of pin 1

DIM.	MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.510	0.575	0.590	0.0201	0.0226	0.0232
A_1	0.220	0.250	0.280	0.0087	0.0098	0.0110
A_2	0.290	0.300	0.310	0.0114	0.0118	0.0122
b	0.297	0.330	0.363	0.0116	0.0129	0.0143
b1		0.250			0.0098	
e		0.500			0.0197	
s	0.210	0.230	0.250	0.0082	0.0090	0.0098
D	0.920	0.960	1.000	0.0362	0.0378	0.0394
E	1.420	1.460	1.500	0.0559	0.0575	0.0591
K	0.028	0.065	0.102	0.0011	0.0025	0.0040

Note

- Use millimeters as the primary measurement.

ECN: T15-0140-Rev. A, 20-Apr-15
DWG: 6035

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Üreticileri görün

Toplu alım ve teklif

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Teklif isteyin

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